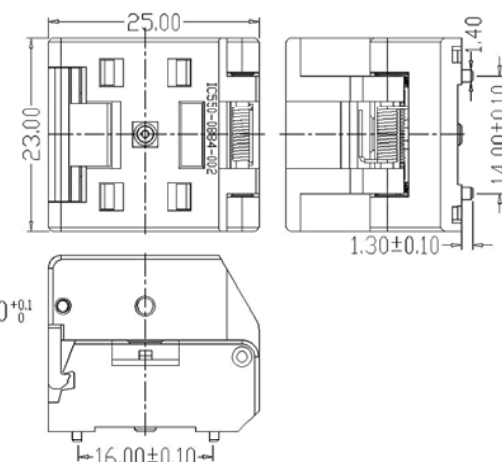
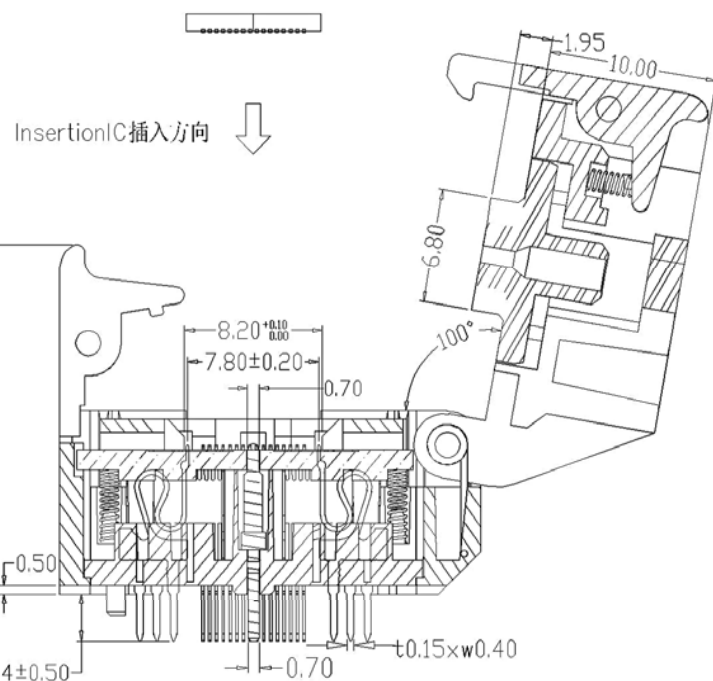
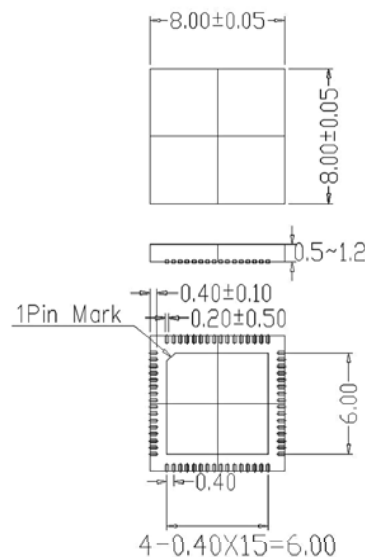




PCB PATTERN (Top View)



SEC.A-A

$$S=2/1$$


APPL ICABLE IC S=2/1

1. MATERIAL AND FINISH

- 1、 SOCKET LID :PEI
- 2、 SOCKET BASE :PEI
- 3、 CONTACTS :BeCu,SELECTIVE Au-AuFLASH OVER NI PLATING
- 4、 SPRINGS :STAINLESS STEEL ,PASSIVATED

2、 SPECIFICATION

- 1、INSULATION RESISTANCE : 1000Mohm or more at 100VDC.
- 2、DIELECTRIC WITHSTANDING VOLTAGE: 100VAC for one minute.
- 3、CONTACT RESISTANCE: 100mohm or less at 20mV (initial).
- 4、OPERATION TEMPERATURE : -40°C~+150°C
- 5、CONTACT FORCE: 0.343N(35gf)/pin (approx).

△ C				DWG NO		PART NAME	QFN-p0.4-64P(8.0X8.0)	
△ B				MATERIAL	SCALE 1:1	TITLE	IC549-0484-010-G	
△ A				QTY 1	UNIT mm			
REV	DESCRIPTION	DATE	CHECK	SHEET 1 OF 1	REV 01			
APPLICATION				APPROVE	DATE	JRS		
ANGLED	FRIST	ROUGH EDGE	ME TRIG	0.1X±0.1	CHECK			DATE
ALL UN-SPECIFIED CHAMFERS-0.2				0.0X±0.0.05	DEGK			DATE 20140512

JRS